

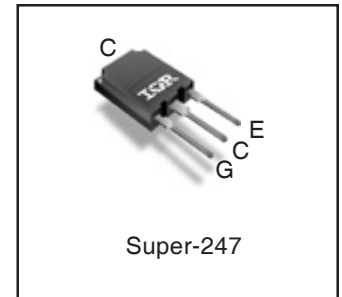
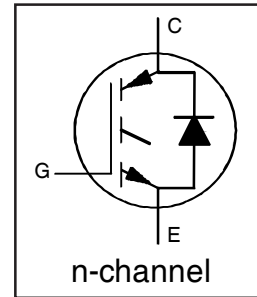
### INSULATED GATE BIPOLAR TRANSISTOR WITH ULTRAFAST SOFT RECOVERY DIODE

$$V_{CES} = 600V$$

$$I_C = 160A, T_C = 100^\circ C$$

$$t_{SC} \geq 5\mu s, T_{J(max)} = 175^\circ C$$

$$V_{CE(on)} \text{ typ.} = 1.70V @ I_C = 120A$$



|          |           |          |
|----------|-----------|----------|
| <b>G</b> | <b>C</b>  | <b>E</b> |
| Gate     | Collector | Emitter  |

#### Applications

- Industrial Motor Drive
- Inverters
- UPS
- Welding

| Features                                            | Benefits                                                                                  |
|-----------------------------------------------------|-------------------------------------------------------------------------------------------|
| Low $V_{CE(ON)}$ and Switching Losses               | High efficiency in a wide range of applications and switching frequencies                 |
| Square RBSOA and Maximum Junction Temperature 175°C | Improved reliability due to rugged hard switching performance and higher power capability |
| Positive $V_{CE(ON)}$ Temperature Coefficient       | Excellent current sharing in parallel operation                                           |
| 5 $\mu$ s short circuit SOA                         | Enables short circuit protection scheme                                                   |
| Lead-Free, RoHS compliant                           | Environmentally friendly                                                                  |

| Base part number | Package Type | Standard Pack |          | Orderable part number |
|------------------|--------------|---------------|----------|-----------------------|
|                  |              | Form          | Quantity |                       |
| IRGPS46160DPbF   | Super-247    | Tube          | 25       | IRGPS46160DPbF        |

#### Absolute Maximum Ratings

| Parameter                                                                            | Max.                                                     | Units |
|--------------------------------------------------------------------------------------|----------------------------------------------------------|-------|
| $V_{CES}$<br>Collector-to-Emitter Voltage                                            | 600                                                      | V     |
| $I_C @ T_C = 25^\circ C$<br>Continuous Collector Current                             | 240 <sup>②</sup>                                         | A     |
| $I_C @ T_C = 100^\circ C$<br>Continuous Collector Current                            | 160                                                      |       |
| $I_{CM}$<br>Pulse Collector Current, $V_{GE} = 15V$                                  | 360                                                      |       |
| $I_{LM}$<br>Clamped Inductive Load Current, $V_{GE} = 20V$ ①                         | 480                                                      |       |
| $I_F @ T_C = 25^\circ C$<br>Diode Continuous Forward Current                         | 240 <sup>②</sup>                                         |       |
| $I_F @ T_C = 100^\circ C$<br>Diode Continuous Forward Current                        | 160 <sup>②</sup>                                         |       |
| $I_{FM}$<br>Diode Maximum Forward Current ④                                          | 480                                                      | V     |
| $V_{GE}$<br>Continuous Gate-to-Emitter Voltage                                       | $\pm 20$                                                 |       |
|                                                                                      | $\pm 30$                                                 | W     |
| $P_D @ T_C = 25^\circ C$<br>Maximum Power Dissipation                                | 750                                                      |       |
| $P_D @ T_C = 100^\circ C$<br>Maximum Power Dissipation                               | 375                                                      | °C    |
| $T_J$<br>Operating Junction and Storage Temperature Range                            | -55 to +175                                              |       |
| $T_{STG}$<br>Soldering Temperature, for 10 sec.<br>Mounting Torque, 6-32 or M3 Screw | 300 (0.063 in. (1.6mm) from case)<br>10 lbf·in (1.1 N·m) |       |

#### Thermal Resistance

| Parameter                                                     | Min. | Typ. | Max. | Units |
|---------------------------------------------------------------|------|------|------|-------|
| $R_{\theta JC}$ (IGBT)<br>Junction-to-Case (IGBT) ②           | —    | —    | 0.20 | °C/W  |
| $R_{\theta JC}$ (Diode)<br>Junction-to-Case (Diode) ②         | —    | —    | 0.63 |       |
| $R_{\theta CS}$<br>Case-to-Sink (flat, greased surface)       | —    | 0.24 | —    |       |
| $R_{\theta JA}$<br>Junction-to-Ambient (typical socket mount) | —    | —    | 40   |       |

**Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)**

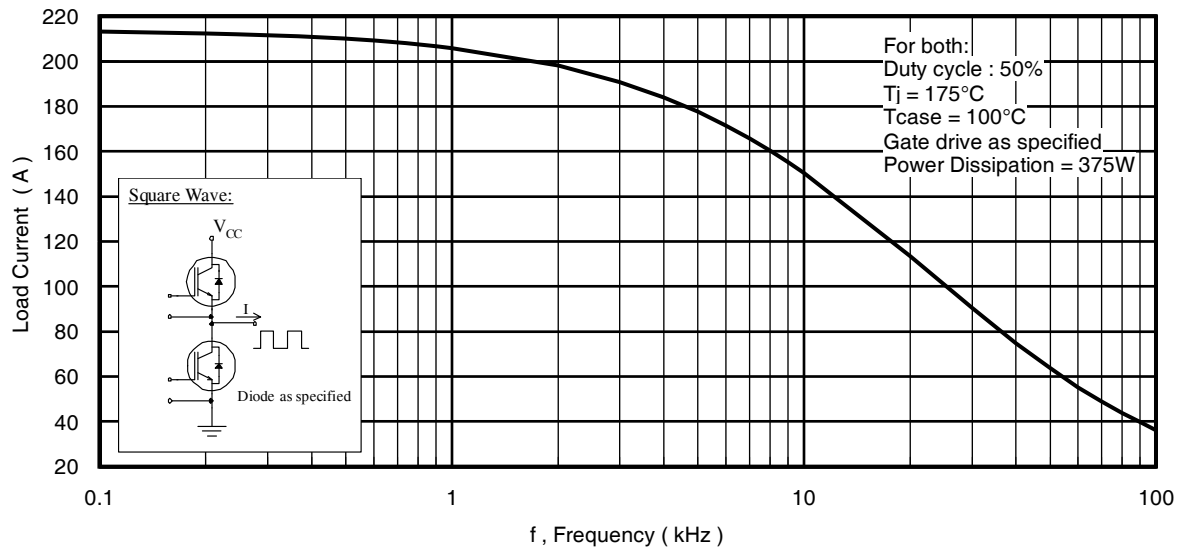
|                                        | Parameter                               | Min. | Typ. | Max. | Units | Conditions                                                                |
|----------------------------------------|-----------------------------------------|------|------|------|-------|---------------------------------------------------------------------------|
| V <sub>(BR)CES</sub>                   | Collector-to-Emitter Breakdown Voltage  | 600  | —    | —    | V     | V <sub>GE</sub> = 0V, I <sub>C</sub> = 100μA ③                            |
| ΔV <sub>(BR)CES</sub> /ΔT <sub>J</sub> | Temperature Coeff. of Breakdown Voltage | —    | 0.27 | —    | V/°C  | V <sub>GE</sub> = 0V, I <sub>C</sub> = 4.0mA (25°C-175°C)                 |
| V <sub>CE(on)</sub>                    | Collector-to-Emitter Saturation Voltage | —    | 1.70 | 2.05 | V     | I <sub>C</sub> = 120A, V <sub>GE</sub> = 15V, T <sub>J</sub> = 25°C       |
|                                        |                                         | —    | 2.15 | —    |       | I <sub>C</sub> = 120A, V <sub>GE</sub> = 15V, T <sub>J</sub> = 150°C      |
|                                        |                                         | —    | 2.20 | —    |       | I <sub>C</sub> = 120A, V <sub>GE</sub> = 15V, T <sub>J</sub> = 175°C      |
| V <sub>GE(th)</sub>                    | Gate Threshold Voltage                  | 4.0  | —    | 6.5  | V     | V <sub>CE</sub> = V <sub>GE</sub> , I <sub>C</sub> = 5.6mA                |
| ΔV <sub>GE(th)</sub> /ΔT <sub>J</sub>  | Threshold Voltage temp. coefficient     | —    | -17  | —    | mV/°C | V <sub>CE</sub> = V <sub>GE</sub> , I <sub>C</sub> = 5.6mA (25°C - 175°C) |
| g <sub>fe</sub>                        | Forward Transconductance                | —    | 77   | —    | S     | V <sub>CE</sub> = 50V, I <sub>C</sub> = 120A                              |
| I <sub>CES</sub>                       | Collector-to-Emitter Leakage Current    | —    | 1.0  | 150  | μA    | V <sub>GE</sub> = 0V, V <sub>CE</sub> = 600V                              |
|                                        |                                         | —    | 2.3  | —    | mA    | V <sub>GE</sub> = 0V, V <sub>CE</sub> = 600V, T <sub>J</sub> = 175°C      |
| V <sub>FM</sub>                        | Diode Forward Voltage Drop              | —    | 2.4  | 3.0  | V     | I <sub>F</sub> = 120A                                                     |
|                                        |                                         | —    | 1.9  | —    |       | I <sub>F</sub> = 120A, T <sub>J</sub> = 175°C                             |
| I <sub>GES</sub>                       | Gate-to-Emitter Leakage Current         | —    | —    | ±400 | nA    | V <sub>GE</sub> = ±20V                                                    |

**Switching Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)**

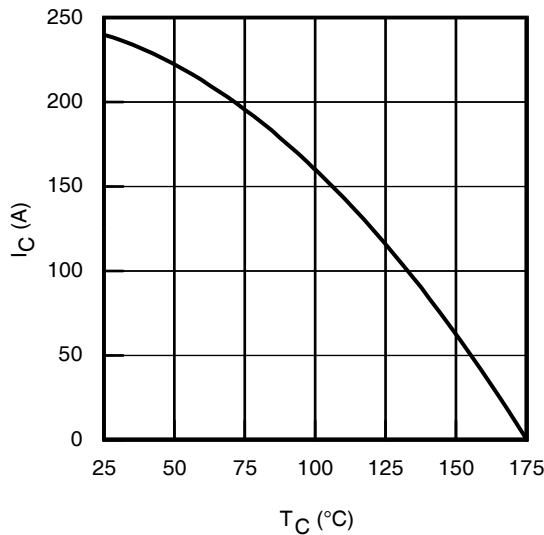
|                     | Parameter                            | Min.        | Typ.  | Max. | Units | Conditions                                                                                                                                             |
|---------------------|--------------------------------------|-------------|-------|------|-------|--------------------------------------------------------------------------------------------------------------------------------------------------------|
| Q <sub>g</sub>      | Total Gate Charge                    | —           | 240   | —    | nC    | I <sub>C</sub> = 120A<br>V <sub>GE</sub> = 15V<br>V <sub>CC</sub> = 400V                                                                               |
| Q <sub>ge</sub>     | Gate-to-Emitter Charge               | —           | 70    | —    |       |                                                                                                                                                        |
| Q <sub>gc</sub>     | Gate-to-Collector Charge             | —           | 90    | —    |       |                                                                                                                                                        |
| E <sub>on</sub>     | Turn-On Switching Loss               | —           | 5750  | —    | μJ    | I <sub>C</sub> = 120A, V <sub>CC</sub> = 400V, V <sub>GE</sub> = 15V<br>R <sub>G</sub> = 4.7Ω, L = 66μH, T <sub>J</sub> = 25°C                         |
| E <sub>off</sub>    | Turn-Off Switching Loss              | —           | 3430  | —    |       |                                                                                                                                                        |
| E <sub>total</sub>  | Total Switching Loss                 | —           | 9180  | —    |       |                                                                                                                                                        |
| t <sub>d(on)</sub>  | Turn-On delay time                   | —           | 80    | —    | ns    | Energy losses include tail<br>& diode reverse recovery ⑥                                                                                               |
| t <sub>r</sub>      | Rise time                            | —           | 70    | —    |       |                                                                                                                                                        |
| t <sub>d(off)</sub> | Turn-Off delay time                  | —           | 190   | —    |       |                                                                                                                                                        |
| t <sub>f</sub>      | Fall time                            | —           | 40    | —    |       |                                                                                                                                                        |
| E <sub>on</sub>     | Turn-On Switching Loss               | —           | 7740  | —    | μJ    | I <sub>C</sub> = 120A, V <sub>CC</sub> = 400V, V <sub>GE</sub> = 15V<br>R <sub>G</sub> = 4.7Ω, L = 66μH, T <sub>J</sub> = 175°C                        |
| E <sub>off</sub>    | Turn-Off Switching Loss              | —           | 4390  | —    |       |                                                                                                                                                        |
| E <sub>total</sub>  | Total Switching Loss                 | —           | 12130 | —    |       |                                                                                                                                                        |
| t <sub>d(on)</sub>  | Turn-On delay time                   | —           | 80    | —    | ns    | Energy losses include tail<br>& diode reverse recovery ⑥                                                                                               |
| t <sub>r</sub>      | Rise time                            | —           | 75    | —    |       |                                                                                                                                                        |
| t <sub>d(off)</sub> | Turn-Off delay time                  | —           | 230   | —    |       |                                                                                                                                                        |
| t <sub>f</sub>      | Fall time                            | —           | 55    | —    |       |                                                                                                                                                        |
| C <sub>ies</sub>    | Input Capacitance                    | —           | 7750  | —    | pF    | V <sub>GE</sub> = 0V<br>V <sub>CC</sub> = 30V<br>f = 1.0Mhz                                                                                            |
| C <sub>oes</sub>    | Output Capacitance                   | —           | 550   | —    |       |                                                                                                                                                        |
| C <sub>res</sub>    | Reverse Transfer Capacitance         | —           | 225   | —    |       |                                                                                                                                                        |
| RBSOA               | Reverse Bias Safe Operating Area     | FULL SQUARE |       |      |       | T <sub>J</sub> = 175°C, I <sub>C</sub> = 480A<br>V <sub>CC</sub> = 480V, V <sub>p</sub> ≤ 600V<br>R <sub>G</sub> = 4.7 Ω, V <sub>GE</sub> = +20V to 0V |
| SCSOA               | Short Circuit Safe Operating Area    | 5           | —     | —    | μs    | V <sub>CC</sub> = 400V, V <sub>p</sub> ≤ 600V<br>R <sub>G</sub> = 4.7 Ω, V <sub>GE</sub> = +15V to 0V                                                  |
| E <sub>rec</sub>    | Reverse Recovery Energy of the Diode | —           | 500   | —    | μJ    | T <sub>J</sub> = 175°C                                                                                                                                 |
| t <sub>rr</sub>     | Diode Reverse Recovery Time          | —           | 130   | —    | ns    | V <sub>CC</sub> = 400V, I <sub>F</sub> = 120A                                                                                                          |
| I <sub>rr</sub>     | Peak Reverse Recovery Current        | —           | 36    | —    | A     | V <sub>GE</sub> = 15V, R <sub>G</sub> = 4.7 Ω, L = 100μH                                                                                               |

**Notes:**

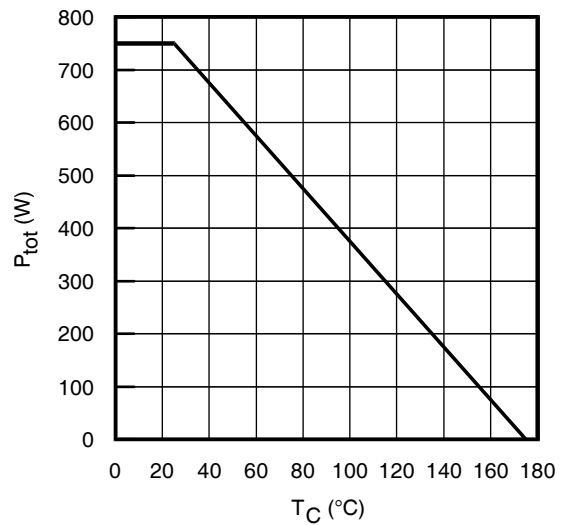
- ① V<sub>CC</sub> = 80% (V<sub>CES</sub>), V<sub>GE</sub> = 20V, L = 66μH, R<sub>G</sub> = 4.7Ω, tested in production I<sub>LM</sub> ≤ 400A.
- ② Pulse width limited by max. junction temperature.
- ③ Refer to AN-1086 for guidelines for measuring V<sub>(BR)CES</sub> safely.
- ④ R<sub>θ</sub> is measured at T<sub>J</sub> of approximately 90°C.
- ⑤ Values influenced by parasitic L and C in measurement.
- ⑥ Calculated continuous current based on maximum allowable junction temperature. Package IGBT current limit is 195A. Package diode current limit is 120A. Note that current limitations arising from heating of the device leads may occur.



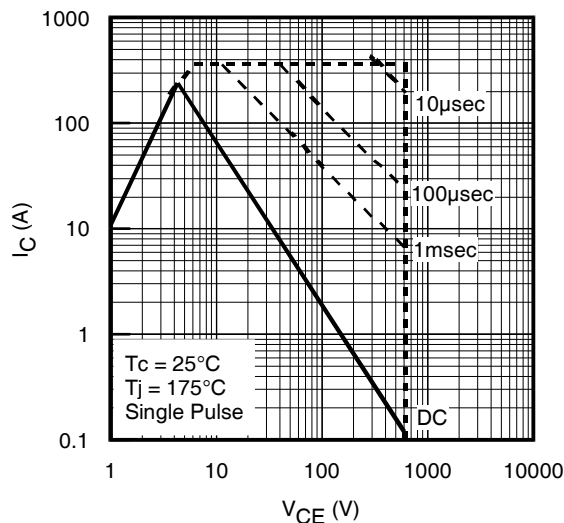
**Fig. 1 - Typical Load Current vs. Frequency**  
(Load Current =  $I_{RMS}$  of fundamental)



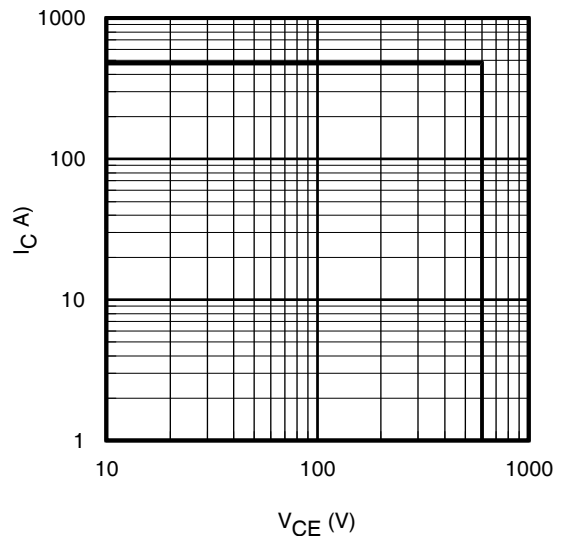
**Fig. 2 - Maximum DC Collector Current vs. Case Temperature**



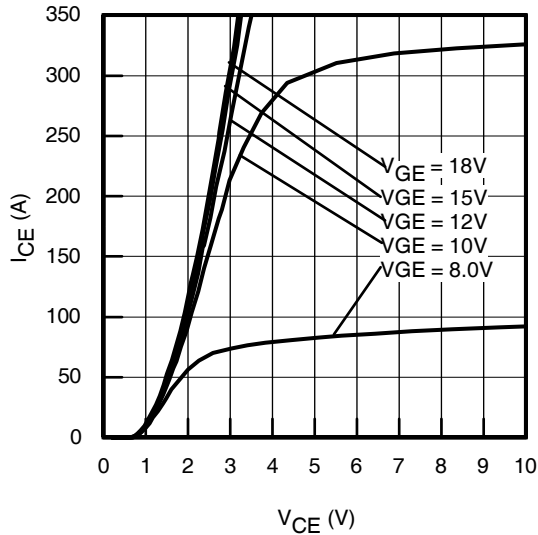
**Fig. 3 - Power Dissipation vs. Case Temperature**



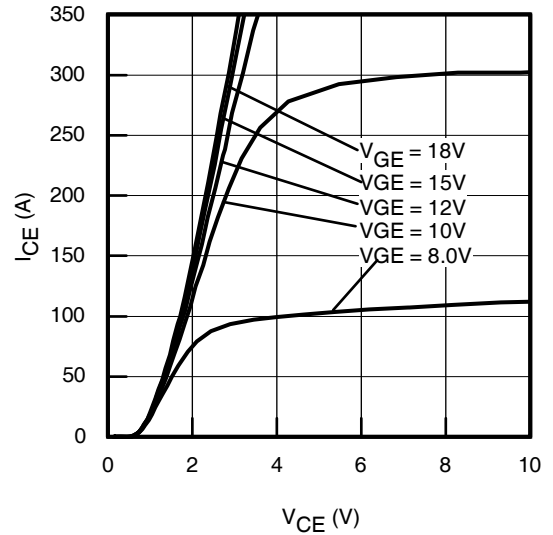
**Fig. 4 - Forward SOA**  
 $T_C = 25^\circ\text{C}$ ,  $T_J \leq 175^\circ\text{C}$ ;  $V_{GE} = 15\text{V}$



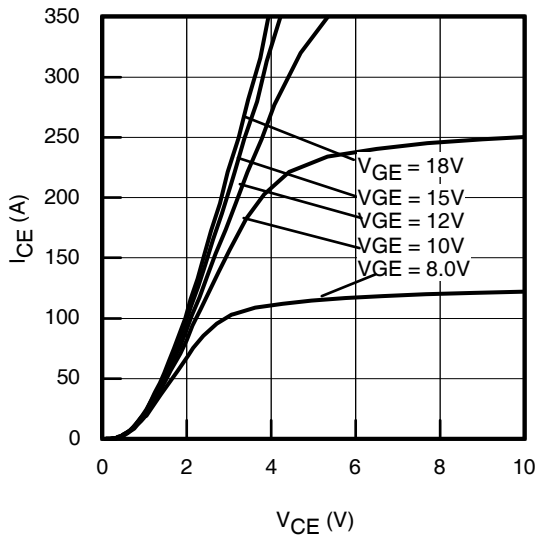
**Fig. 5 - Reverse Bias SOA**  
 $T_J = 175^\circ\text{C}$ ;  $V_{GE} = 20\text{V}$



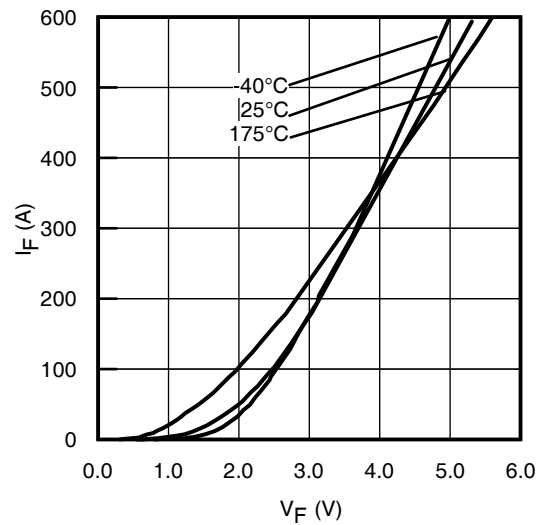
**Fig. 6** - Typ. IGBT Output Characteristics  
 $T_J = -40^\circ\text{C}$ ;  $t_p = 80\mu\text{s}$



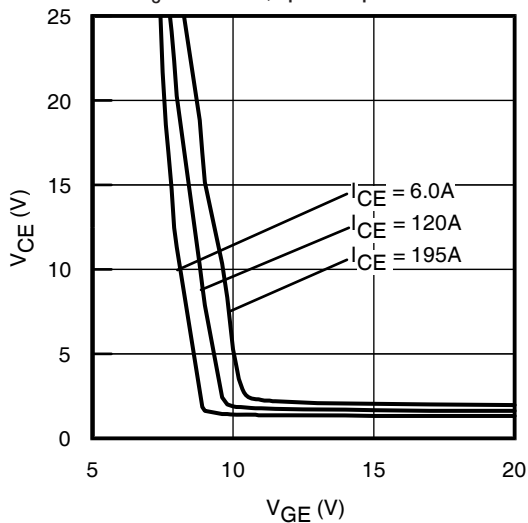
**Fig. 7** - Typ. IGBT Output Characteristics  
 $T_J = 25^\circ\text{C}$ ;  $t_p = 80\mu\text{s}$



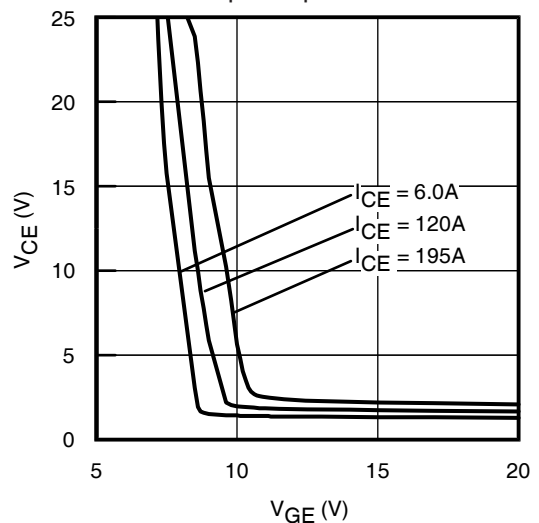
**Fig. 8** - Typ. IGBT Output Characteristics  
 $T_J = 175^\circ\text{C}$ ;  $t_p = 80\mu\text{s}$



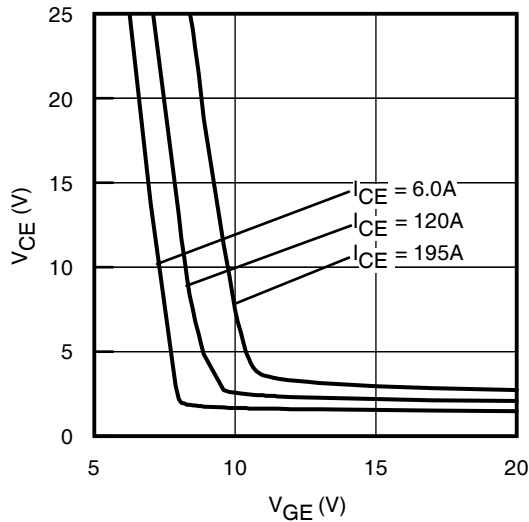
**Fig. 9** - Typ. Diode Forward Characteristics  
 $t_p = 80\mu\text{s}$



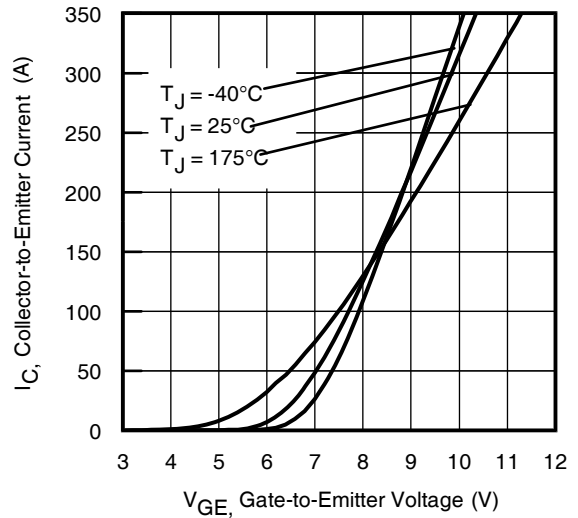
**Fig. 10** - Typical  $V_{CE}$  vs.  $V_{GE}$   
 $T_J = -40^\circ\text{C}$



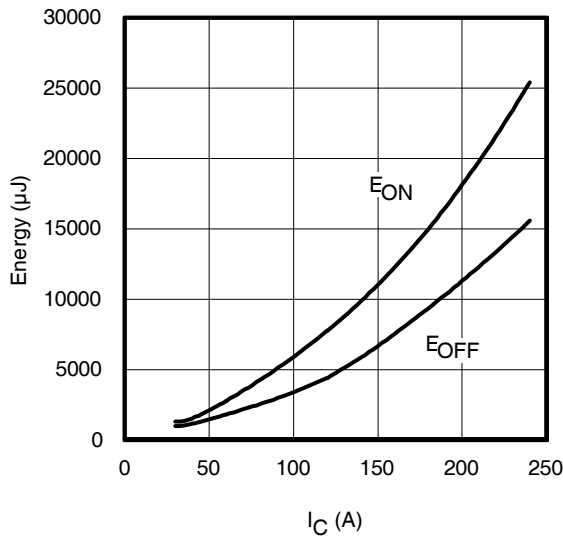
**Fig. 11** - Typical  $V_{CE}$  vs.  $V_{GE}$   
 $T_J = 25^\circ\text{C}$



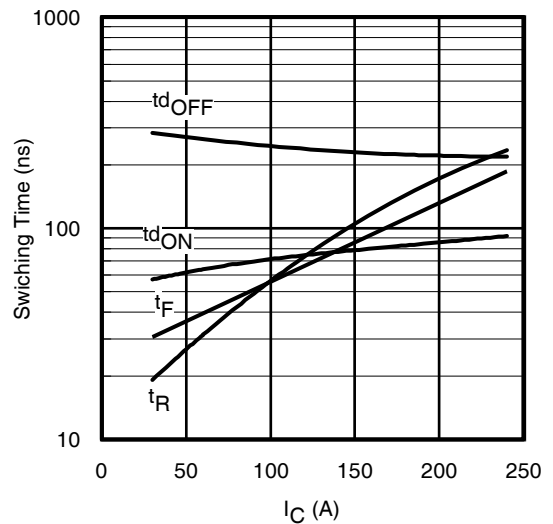
**Fig. 12** - Typical  $V_{CE}$  vs.  $V_{GE}$   
 $T_J = 175^\circ\text{C}$



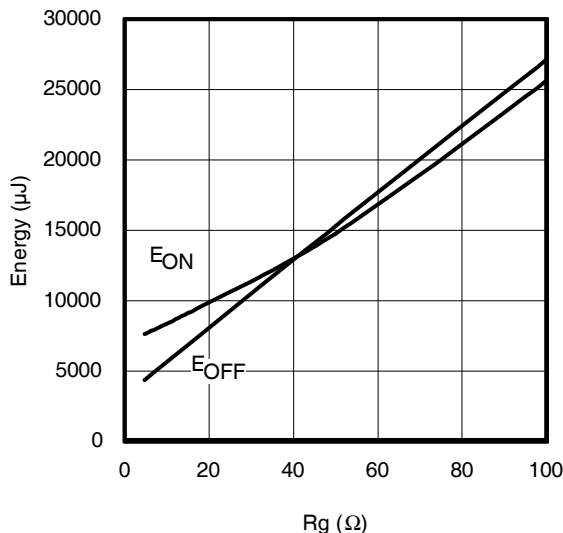
**Fig. 13** - Typ. Transfer Characteristics  
 $V_{CE} = 50\text{V}$ ;  $t_p = 10\mu\text{s}$



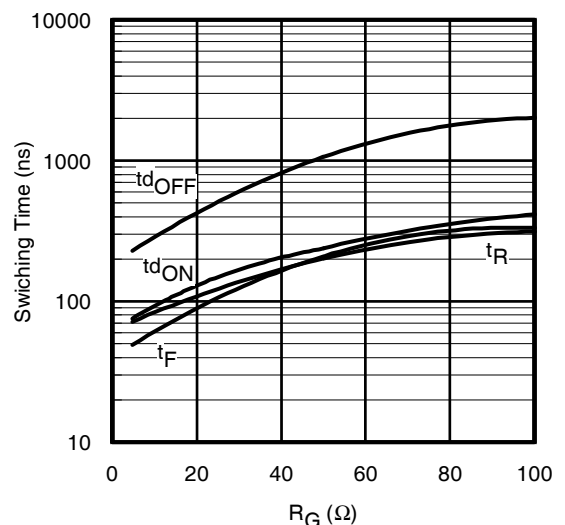
**Fig. 14** - Typ. Energy Loss vs.  $I_C$   
 $T_J = 175^\circ\text{C}$ ;  $L = 66\mu\text{H}$ ;  $V_{CE} = 400\text{V}$ ;  $R_G = 4.7\Omega$ ;  $V_{GE} = 15\text{V}$



**Fig. 15** - Typ. Switching Time vs.  $I_C$   
 $T_J = 175^\circ\text{C}$ ;  $L = 66\mu\text{H}$ ;  $V_{CE} = 400\text{V}$ ;  $R_G = 4.7\Omega$ ;  $V_{GE} = 15\text{V}$



**Fig. 16** - Typ. Energy Loss vs.  $R_G$   
 $T_J = 175^\circ\text{C}$ ;  $L = 66\mu\text{H}$ ;  $V_{CE} = 400\text{V}$ ;  $I_{CE} = 120\text{A}$ ;  $V_{GE} = 15\text{V}$



**Fig. 17** - Typ. Switching Time vs.  $R_G$   
 $T_J = 175^\circ\text{C}$ ;  $L = 66\mu\text{H}$ ;  $V_{CE} = 400\text{V}$ ;  $I_{CE} = 120\text{A}$ ;  $V_{GE} = 15\text{V}$

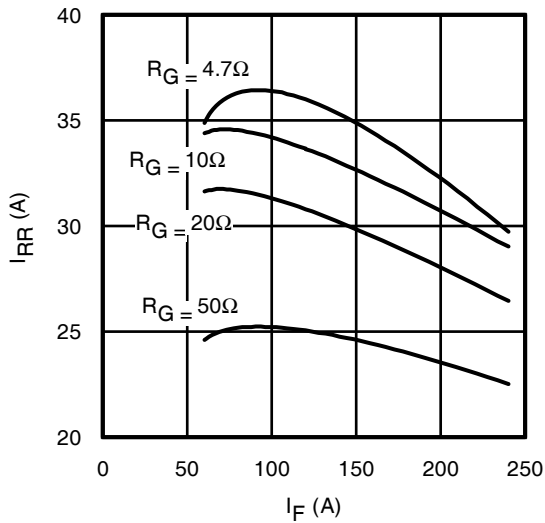


Fig. 18 - Typ. Diode  $I_{RR}$  vs.  $I_F$   
 $T_J = 175^\circ\text{C}$

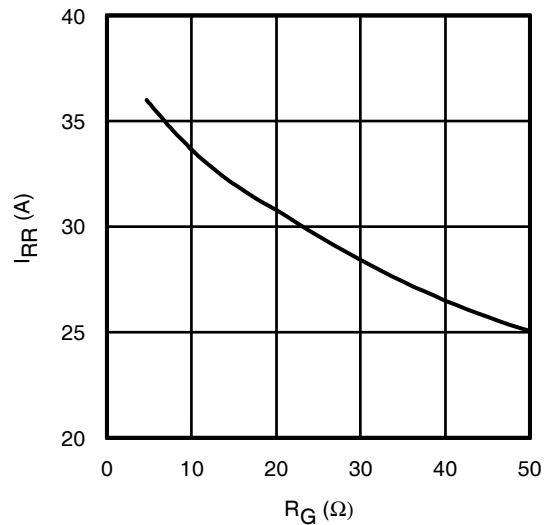


Fig. 19 - Typ. Diode  $I_{RR}$  vs.  $R_G$   
 $T_J = 175^\circ\text{C}$

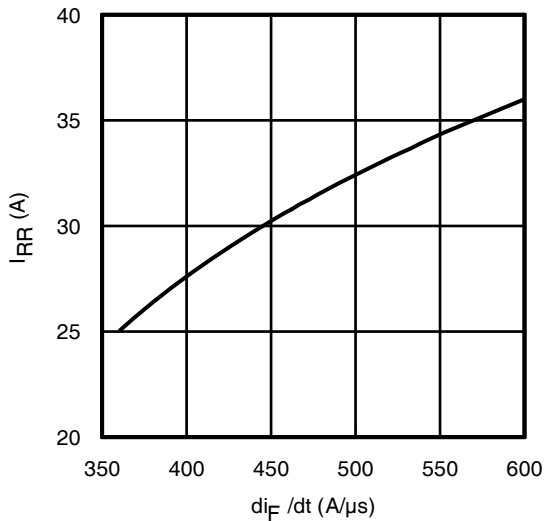


Fig. 20 - Typ. Diode  $I_{RR}$  vs.  $di_F/dt$   
 $V_{CC} = 400\text{V}$ ;  $V_{GE} = 15\text{V}$ ;  $I_F = 120\text{A}$ ;  $T_J = 175^\circ\text{C}$

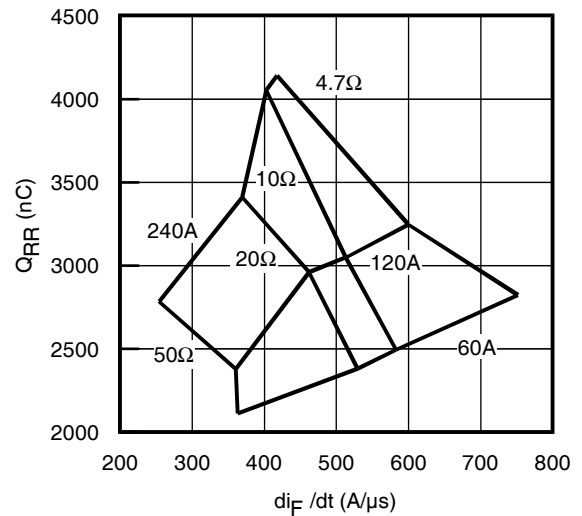


Fig. 21 - Typ. Diode  $Q_{RR}$  vs.  $di_F/dt$   
 $V_{CC} = 400\text{V}$ ;  $V_{GE} = 15\text{V}$ ;  $T_J = 175^\circ\text{C}$

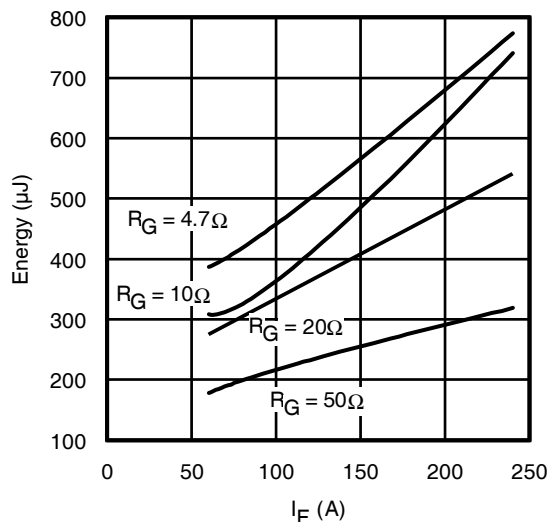


Fig. 22 - Typ. Diode  $E_{RR}$  vs.  $I_F$   
 $T_J = 175^\circ\text{C}$

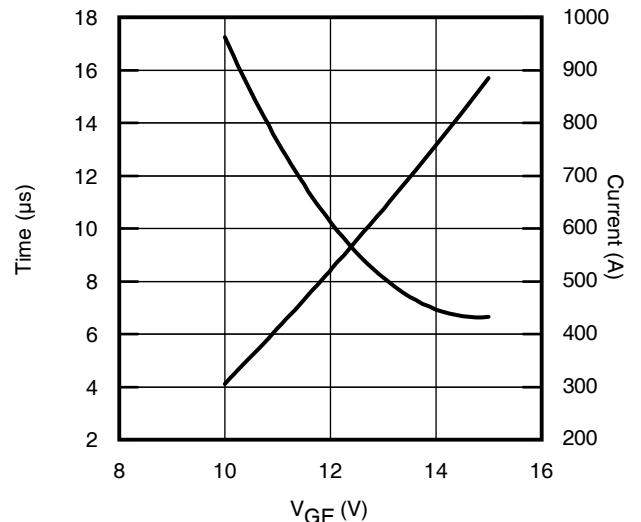
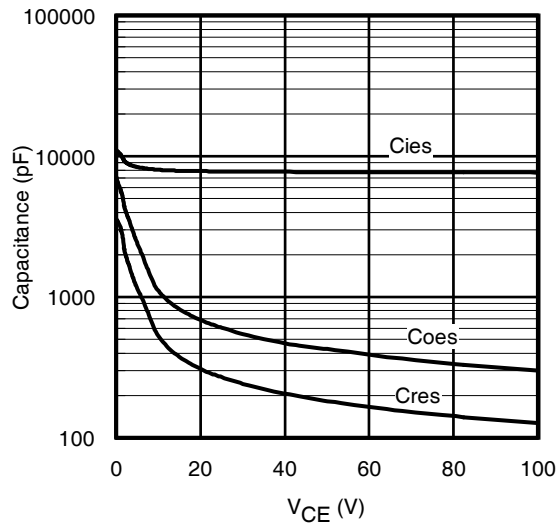
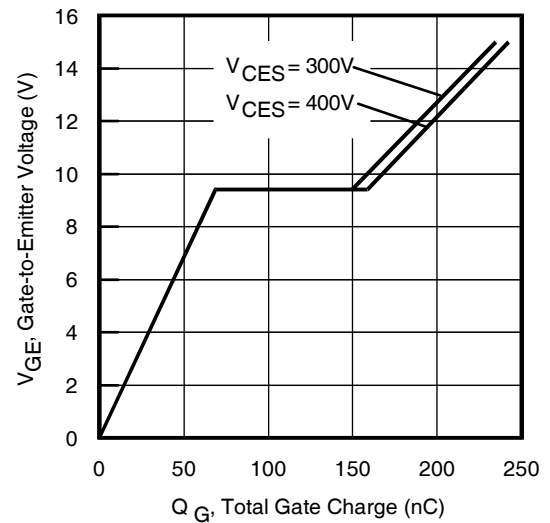


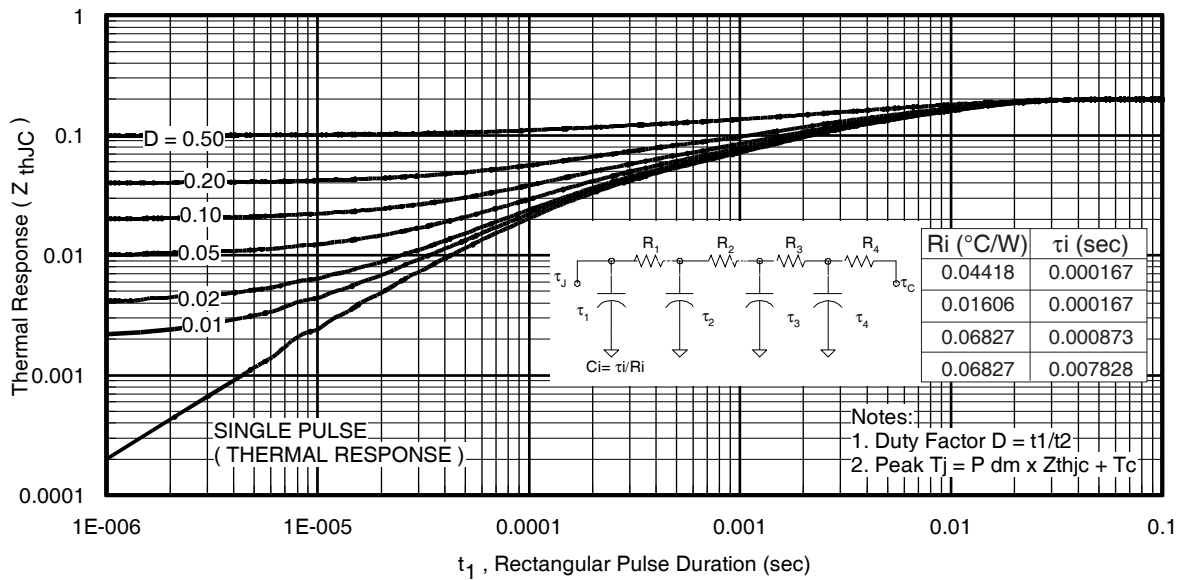
Fig. 23 -  $V_{GE}$  vs. Short Circuit Time  
 $V_{CC} = 400\text{V}$ ;  $T_C = 25^\circ\text{C}$



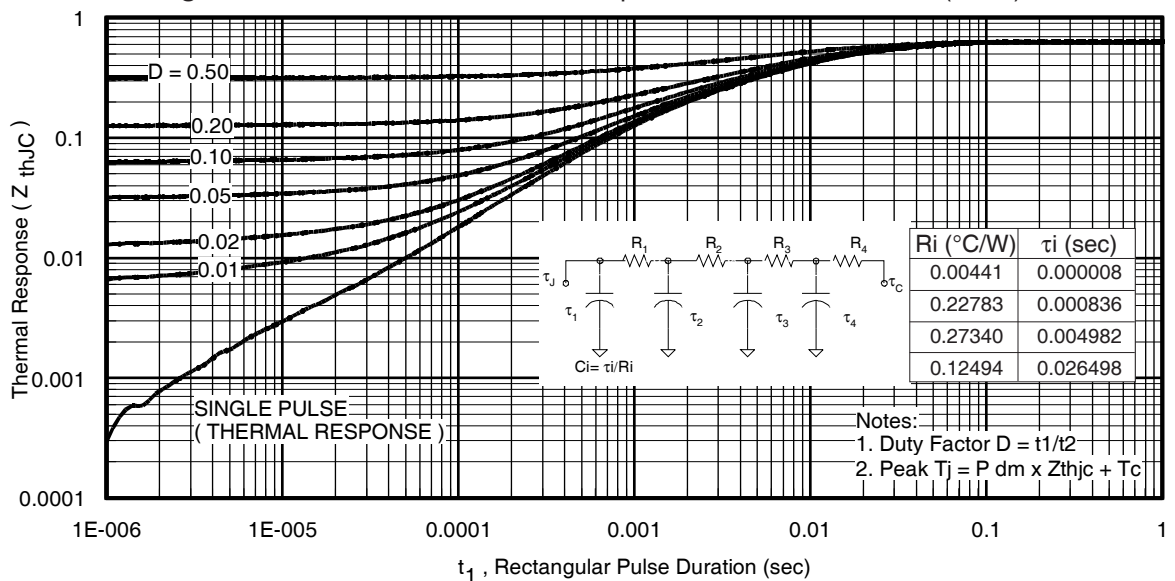
**Fig. 24 - Typ. Capacitance vs.  $V_{CE}$**   
 $V_{GE} = 0V$ ;  $f = 1MHz$



**Fig. 25 - Typical Gate Charge vs.  $V_{GE}$**   
 $I_{CE} = 120A$ ;  $L = 100\mu H$



**Fig. 26. Maximum Transient Thermal Impedance, Junction-to-Case (IGBT)**



**Fig. 27. Maximum Transient Thermal Impedance, Junction-to-Case (DIODE)**

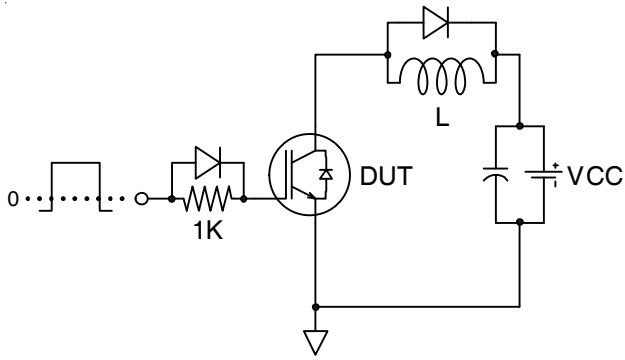


Fig.C.T.1 - Gate Charge Circuit (turn-off)

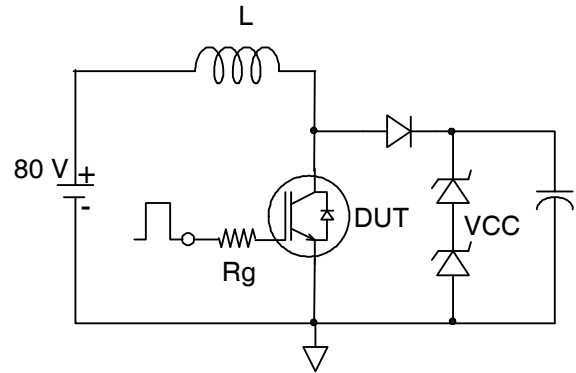


Fig.C.T.2 - RBSOA Circuit

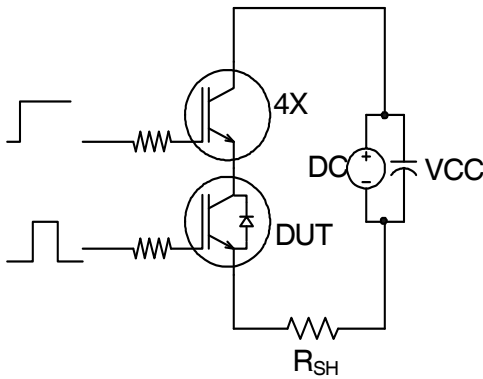


Fig.C.T.3 - S.C. SOA Circuit

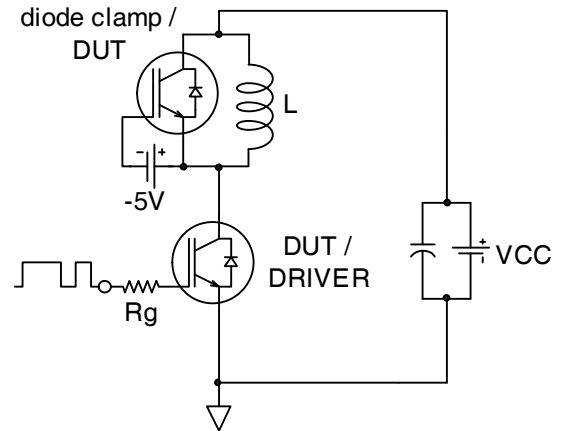


Fig.C.T.4 - Switching Loss Circuit

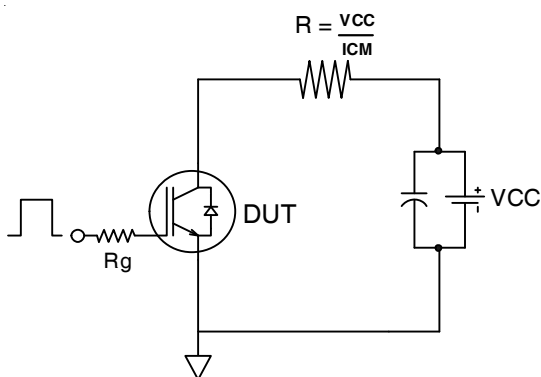


Fig.C.T.5 - Resistive Load Circuit

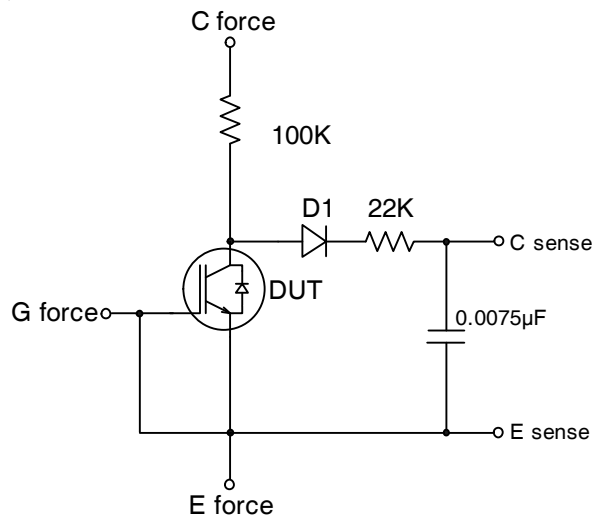
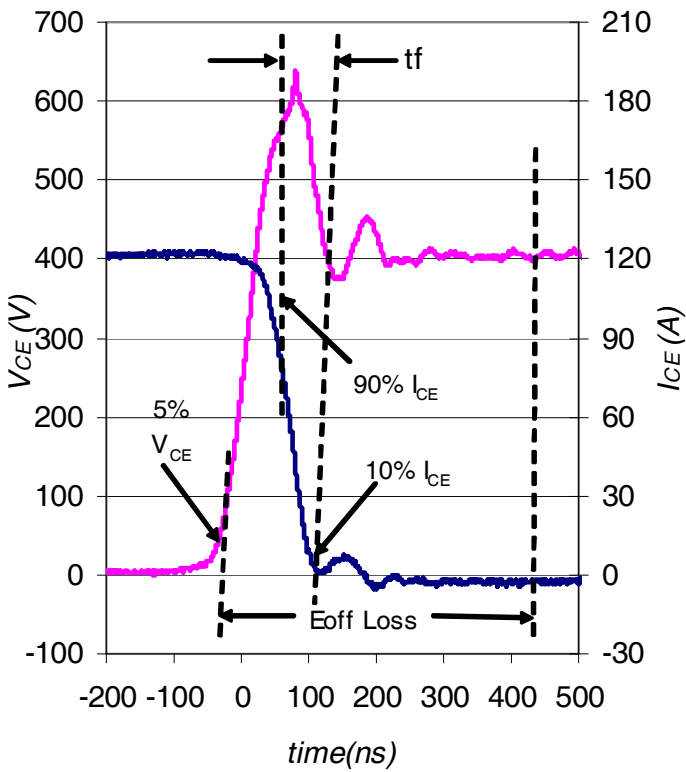
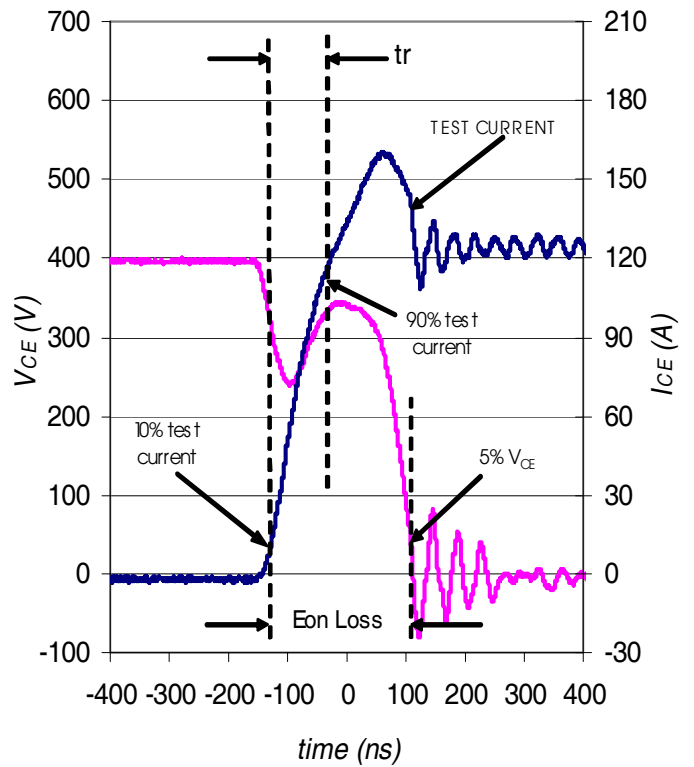


Fig.C.T.6 - BVCES Filter Circuit

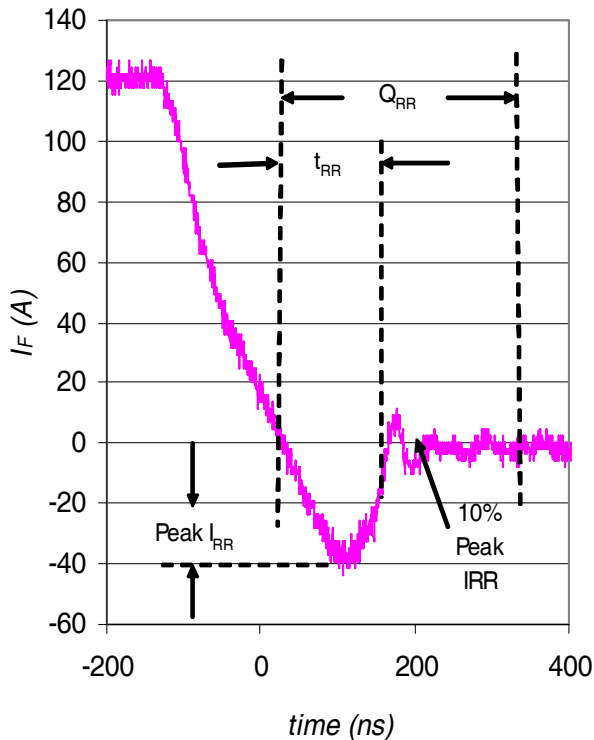




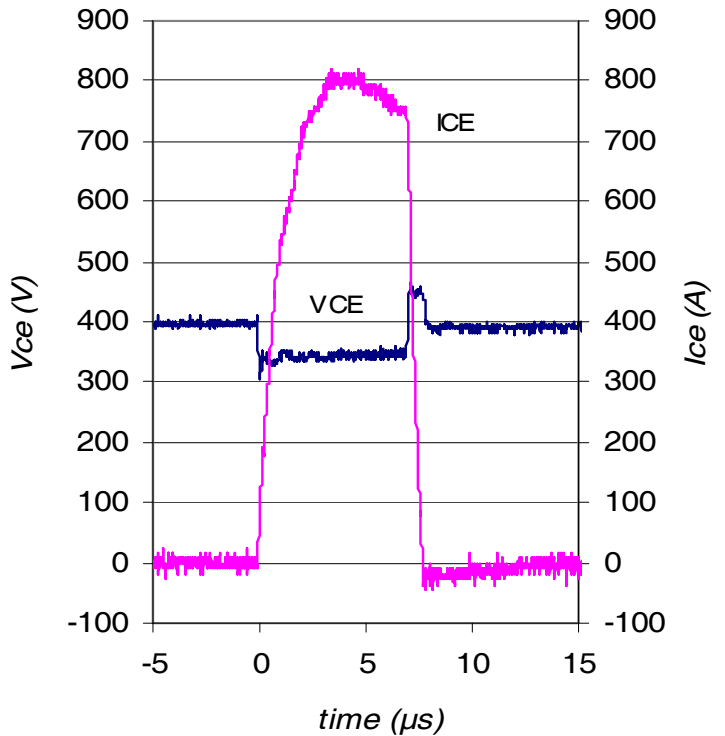
**Fig. WF1** - Typ. Turn-off Loss Waveform  
@  $T_J = 175^\circ\text{C}$  using Fig. CT.4



**Fig. WF2** - Typ. Turn-on Loss Waveform  
@  $T_J = 175^\circ\text{C}$  using Fig. CT.4

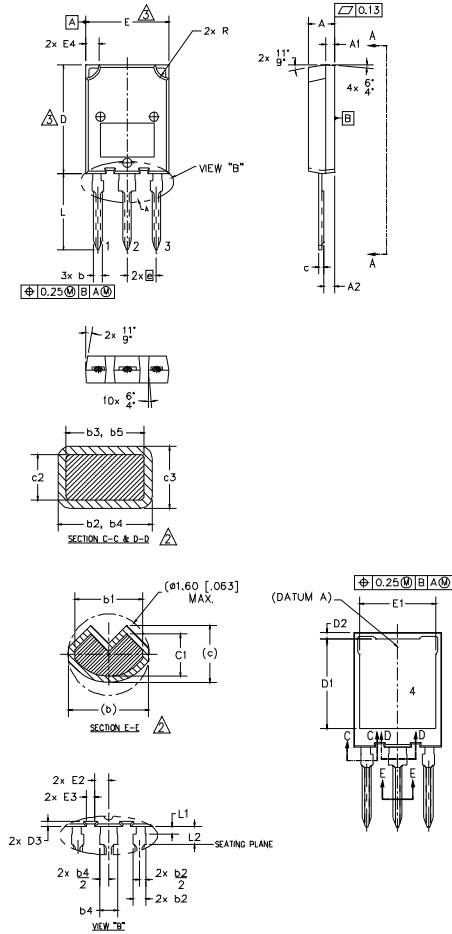


**Fig. WF3** - Typ. Diode Recovery Waveform  
@  $T_J = 175^\circ\text{C}$  using Fig. CT.4



**Fig. WF4** - Typ. S.C. Waveform  
@  $T_J = 25^\circ\text{C}$  using Fig. CT.3

# Case Outline and Dimensions — Super-247



- NOTES:
1. DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M-1994
  2. DIMENSIONS b1, b3, b5, c1 & c3 APPLY TO BASE METAL ONLY.
  3. DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.127 [.005"] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTER EXTREMES OF THE PLASTIC BODY.
  4. ALL DIMENSIONS SHOWN IN MILLIMETERS.
  5. CONTROLLING DIMENSION: MILLIMETER.
  6. OUTLINE CONFORMS TO JEDEC OUTLINE TO-274AA

| SYMBOL | DIMENSIONS  |       |          |      | NOTES |
|--------|-------------|-------|----------|------|-------|
|        | MILLIMETERS |       | INCHES   |      |       |
|        | MIN.        | MAX.  | MIN.     | MAX. |       |
| A      | 4.50        | 5.50  | .177     | .217 |       |
| A1     | 1.45        | 2.15  | .057     | .085 |       |
| A2     | 1.65        | 2.35  | .065     | .093 |       |
| b      | 1.45        | 1.60  | .054     | .063 |       |
| b1     | 1.40        | 1.50  | .055     | .059 | 2     |
| b2     | 2.00        | 2.40  | .079     | .094 |       |
| b3     | 1.95        | 2.35  | .077     | .093 | 2     |
| b4     | 3.00        | 3.15  | .118     | .124 |       |
| b5     | 2.95        | 3.35  | .116     | .132 | 2     |
| c      | 1.10        | 1.30  | .043     | .051 |       |
| c1     | 0.90        | 1.10  | .035     | .043 | 2     |
| c2     | 0.65        | 0.85  | .026     | .033 |       |
| c3     | 0.50        | 0.70  | .020     | .028 | 2     |
| D      | 19.80       | 20.80 | .780     | .819 | 3     |
| D1     | 15.50       | 16.10 | .610     | .634 |       |
| D2     | 0.70        | 1.30  | .028     | .051 |       |
| D3     | 0.75        | 1.25  | .030     | .049 |       |
| E      | 15.10       | 16.10 | .594     | .634 | 3     |
| E1     | 13.30       | 13.90 | .524     | .547 |       |
| E2     | 2.25        | 2.70  | .089     | .109 |       |
| E3     | 1.20        | 1.70  | .047     | .067 |       |
| E4     | 2.00        | 3.00  | .079     | .118 |       |
| e      | 5.45 BSC    |       | .215 BSC |      |       |
| L      | 13.80       | 14.80 | .535     | .583 |       |
| L1     | 1.00        | 1.60  | .039     | .063 |       |
| L2     | 3.85        | 4.25  | .152     | .167 |       |
| R      | 2.00        | 3.00  | .079     | .118 |       |

**LEAD ASSIGNMENTS**

**MOSEFT**

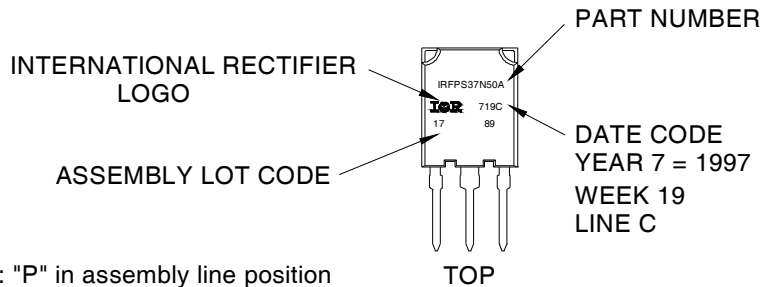
- 1.- GATE
- 2.- DRAIN
- 3.- SOURCE
- 4.- DRAIN

**IGBT**

- 1.- GATE
- 2.- COLLECTOR
- 3.- EMITTER
- 4.- COLLECTOR

## Super-247 (TO-274AA) Part Marking Information

EXAMPLE: THIS IS AN IRFPS37N50A WITH  
ASSEMBLY LOT CODE 1789  
ASSEMBLED ON WW 19, 1997  
IN THE ASSEMBLY LINE "C"



Note: "P" in assembly line position indicates "Lead-Free"

Note: For the most current drawing please refer to IR website at <http://www.irf.com/package/>

**Qualification Information<sup>†</sup>**

|                                   |                      |                                                                   |     |
|-----------------------------------|----------------------|-------------------------------------------------------------------|-----|
| <b>Qualification Level</b>        |                      | Industrial<br>(per International Rectifier's internal guidelines) |     |
| <b>Moisture Sensitivity Level</b> |                      | Super-247                                                         | N/A |
| <b>ESD</b>                        | Human Body Model     | Class H3B ( 8000V ) <sup>††</sup><br>AEC-Q101-001                 |     |
|                                   | Charged Device Model | Class C5 (1125V ) <sup>††</sup><br>AEC-Q101-005                   |     |
| <b>RoHS Compliant</b>             |                      | Yes                                                               |     |

† Qualification standards can be found at International Rectifier's web site: <http://www.irf.com/product-info/reliability>

†† Highest passing voltage.

**Revision History**

| <b>Date</b> | <b>Comments</b>                                                                                                                                                                                   |
|-------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 11/14/2014  | <ul style="list-style-type: none"> <li>• Added note ④ to I<sub>FM</sub> Diode Maximum Forward Current on page 1.</li> <li>• Added note ⑤ to switching losses test condition on page 2.</li> </ul> |

## Данный компонент на территории Российской Федерации

### Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

### Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: [info@moschip.ru](mailto:info@moschip.ru)

Skype отдела продаж:

moschip.ru

moschip.ru\_4

moschip.ru\_6

moschip.ru\_9